

TNETA1556 155.52-MBIT/S CLOCK-RECOVERY DEVICE

SDNS015C – FEBRUARY 1994 – REVISED JUNE 1995

- Recovers a 155.52-MHz Clock Signal From a 155.52-Mbit/s STS-3/STM-1 NRZ Data Stream
- Accepts ECL or Pseudo-ECL (PECL) Input Voltage Levels on the Input Data Stream
- Provides a Separate Pseudo-ECL-to-True-ECL Converter for an Additional Data Signal Requiring Conversion
- Requires a Single 5-V Supply

description

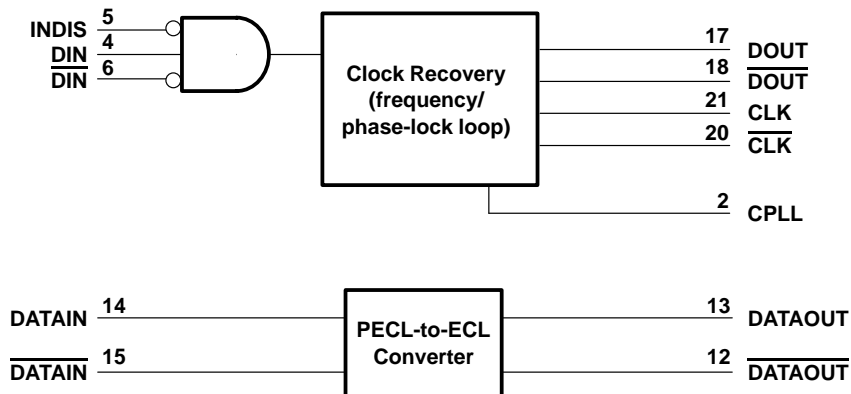
The TNETA1556 device recovers an embedded clock signal from a 155.52-Mbit/s STS-3/STM-1 nonreturn-to-zero (NRZ) data stream using a frequency/phase-lock loop. This device accepts either ECL or pseudo-ECL (ECL signals referenced to 5 V instead of GND) input voltage levels. The recovered clock and data outputs are ECL compatible. The serial data input and recovered clock and data outputs are differential to provide maximum noise immunity.

The input disable (INDIS) disconnects the incoming serial data stream from the clock-recovery circuitry. When the INDIS input is high, the data output is forced low and the clock-recovery circuitry maintains the output frequency present at the time the input was disabled for a specific amount of time. This time is dependent upon the value of the capacitor in the loop filter.

A pseudo-ECL-to-true-ECL converter is included in the device for those applications where an interface between the two different voltage levels is required. An example of such an application is an optical transmitter that requires ECL input voltage levels and a parallel-to-serial converter with ECL-level outputs.

The TNETA1556 requires only a positive 5-V supply ($5\text{ V} \pm 5\%$) for operation. This device is specified for operation over a temperature range of -40°C to 85°C .

functional block diagram



DW PACKAGE (TOP VIEW)			
V _{CC}	1	24	TEST1
CPLL	2	23	TEST2
GND	3	22	V _{CC}
DIN	4	21	CLK
INDIS	5	20	CLK
DIN	6	19	GND
V _{CC}	7	18	DOUT
GND	8	17	DOUT
TESTOUT	9	16	V _{CC}
GND	10	15	DATAIN
V _{CC}	11	14	DATAIN
DATAOUT	12	13	DATAOUT

PRODUCT PREVIEW



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCT PREVIEW information concerns products in the formative or design phase of development. Characteristic data and other specifications are design goals. Texas Instruments reserves the right to change or discontinue these products without notice.

**TEXAS
INSTRUMENTS**

POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 1995, Texas Instruments Incorporated

TNETA1556

155.52-MBIT/S CLOCK-RECOVERY DEVICE

SDNS015C – FEBRUARY 1994 – REVISED JUNE 1995

Terminal Functions

TERMINAL NAME	NO.	I/O	DESCRIPTION
$\overline{\text{CLK}}$, CLK	20, 21	O	Recovered clock. ECL compatible.
CPLL	2	I	Capacitor connection for phase-lock-loop filter ($C_{\text{PLL}} = 0.1 \mu\text{F}$ recommended)
DATAIN, $\overline{\text{DATAIN}}$	14, 15	I	Pseudo-ECL-compatible input for pseudo-ECL-to-ECL converter
DATAOUT, $\overline{\text{DATAOUT}}$	12, 13	O	ECL-compatible output for pseudo-ECL converter
DIN, $\overline{\text{DIN}}$	4, 6	I	Serial data input. ECL or pseudo-ECL compatible.
DOUT, $\overline{\text{DOUT}}$	18, 17	O	Serial data output. ECL compatible.
GND	3, 8, 10, 19		Ground (0-V reference)
INDIS	5	I	Input disable (TTL compatible). The device ignores the input data when INDIS is active and forces DOUT low and $\overline{\text{DOUT}}$ high.
TESTOUT	9	O	Manufacturing test output. Leave open.
TEST2	23	I	Manufacturing test input. Tie to GND.
TEST1	24	I	Manufacturing test input. Tie to GND.
VCC	1, 7, 11, 16, 22		Supply voltage

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, VCC (see Note 1)	–0.5 V to 7 V
Input voltage range: TTL	–1.2 V to 7 V
ECL	–2.5 V to 0
PECL	0 V to 7 V
Operating free-air temperature range, T _A	–40°C to 85°C
Storage temperature range, T _{stg}	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values are with respect to GND.

recommended operating conditions

		MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.75	5	5.25	V
V _{IH}	High-level input voltage	TTL	2		V
		PECL (see Note 2)	VCC – 1.1	VCC – 0.8	
		ECL	–1.1	–0.8	
V _{IL}	Low-level input voltage	TTL		0.8	V
		PECL (see Note 2)	VCC – 1.9	VCC – 1.5	
		ECL	–1.9	–1.5	
I _{IK}	Input clamp current, TTL			–18	mA
T _A	Operating free-air temperature	–40		85	°C

NOTE 2: The algebraic convention, in which the least positive (most negative) value is designated minimum, is used in this data sheet for logic-level voltages only.

PRODUCT PREVIEW



POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER			TEST CONDITIONS		MIN	TYP	MAX	UNIT
V _{OH}	High-level output voltage	CLK, $\overline{\text{CLK}}$, DATAOUT, $\overline{\text{DATAOUT}}$, DOUT, $\overline{\text{DOUT}}$	V _{CC} = 4.75 V,	See Notes 2 and 3	–1.02		–0.75	V
V _{OL}	Low-level output voltage	CLK, $\overline{\text{CLK}}$, DATAOUT, $\overline{\text{DATAOUT}}$, DOUT, $\overline{\text{DOUT}}$	V _{CC} = 4.75 V,	See Notes 2 and 3	–1.81		–1.58	V
V _{IK}	Input clamp voltage	INDIS	V _{CC} = 4.75 V,	I _I = –18 mA			–1.2	V
I _I	Input current	INDIS	V _{CC} = 5.25 V,	V _I = V _{CC} or GND			±1	μA
I _{IH}	High-level input current	DIN, $\overline{\text{DIN}}$, DATAIN, $\overline{\text{DATAIN}}$	V _{CC} = 5.25 V,	V _I = 4.45 V (PECL) V _I = –0.84 V (ECL)			50	μA
I _{IL}	Low-level input current	DIN, $\overline{\text{DIN}}$, DATAIN, $\overline{\text{DATAIN}}$	V _{CC} = 5.25 V,	V _I = 3.35 V (PECL) V _I = –1.8 V (ECL)			50	μA
I _{CC}	Supply current		V _{CC} = 5.25 V, Outputs open	f _i = 155.52 Mbit/s,		71	100	mA
			V _{CC} = 5.25 V, See Note 4	f _i = 155.52 Mbit/s,		112	150	

- NOTES: 2. The algebraic convention, in which the least positive (most negative) value is designated minimum, is used in this data sheet for logic-level voltages only.
3. These outputs are terminated through a 50-Ω resistor to –2 V.
4. DOUT, $\overline{\text{DOUT}}$, CLK, $\overline{\text{CLK}}$, DATAOUT, and $\overline{\text{DATAOUT}}$ are terminated with a 50-Ω resistor to –2 V.

operating characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Acquisition time	See Note 5	C _{PLL} = 330 pF	1		ms
		C _{PLL} = 0.1 μF	3		
Deviation of clock sampling point, t _{csp}		–800		800	ps
RMS jitter, recovered clock	See Note 6		1.5°	4°	°RMS
Input data rate			155.52		Mb/s
Duty cycle, recovered clock	See Note 3	45%		55%	
Maximum number of consecutive bits (1 or 0) in input data stream	See Note 7	100	450		

- NOTES: 3. These outputs are terminated through a 50-Ω resistor to –2 V.
5. Acquisition time is the time required to achieve a valid clock output while applying a 2⁷ – 1 pseudo-random bit sequence.
6. RMS jitter is measured with a 2³¹ – 1 pseudo-random bit sequence.
7. This measurement is made with a 2¹³ – 1 pseudo-random bit sequence with string substitution.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V ± 0.5 V (unless otherwise noted) (see Figure 1)

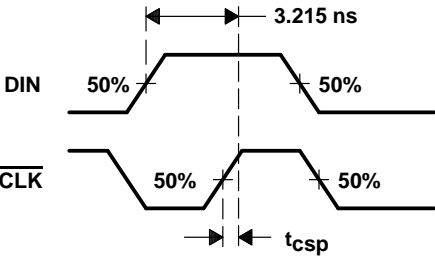
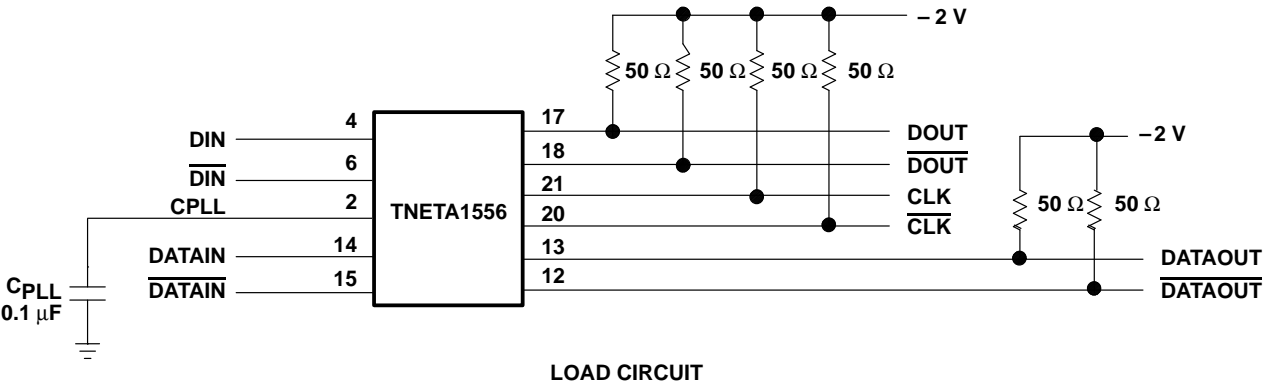
PARAMETER	FROM (INPUT)	TO (OUTPUT)	MIN	MAX	UNIT
t _{PLH}	DATAIN or $\overline{\text{DATAIN}}$	DATAOUT or $\overline{\text{DATAOUT}}$	1.5	4.5	ns
t _{PHL}			1.5	4.5	

TNETA1556

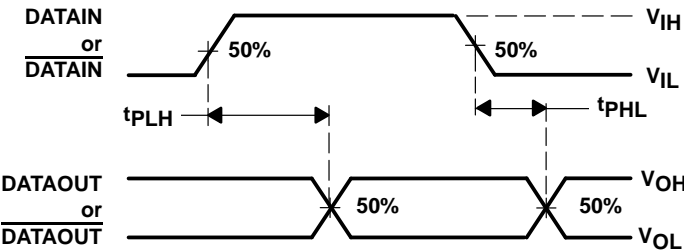
155.52-MBIT/S CLOCK-RECOVERY DEVICE

SDNS015C – FEBRUARY 1994 – REVISED JUNE 1995

PARAMETER MEASUREMENT INFORMATION



VOLTAGE WAVEFORMS
OUTPUT CLOCK AND DATA TIMING



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES

Figure 1. Load Circuit and Voltage Waveforms

PRODUCT PREVIEW

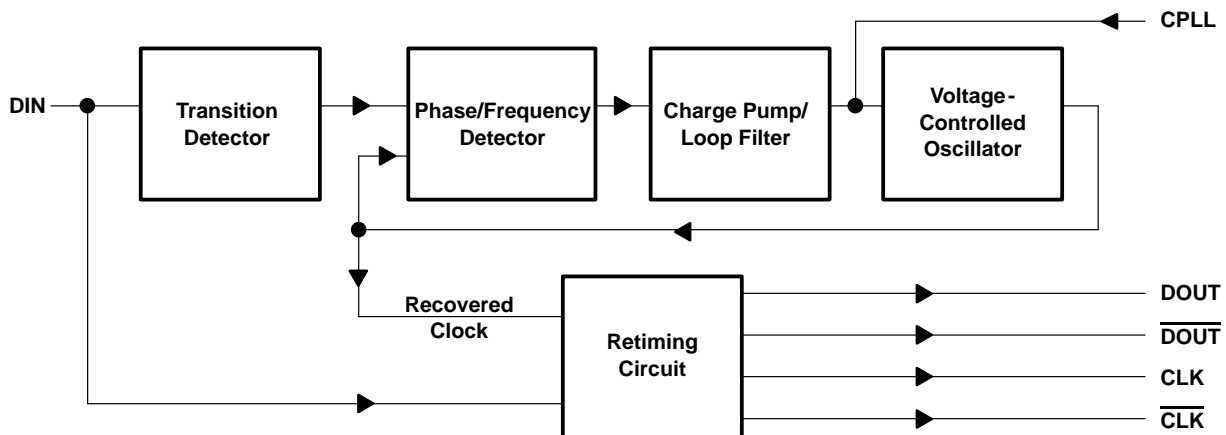
APPLICATION INFORMATION

The TNETA1556 clock-recovery device provides clock recovery and data retiming on a nonreturn to zero (NRZ) serial input data stream. The device uses an analog phase-lock loop (APLL) with an integrated voltage-controlled oscillator (VCO) to recover the imbedded clock signal from incoming data. A loop-filter capacitor is the only external component required for the proper operation of the device. The TNETA1556 is designed for operation with a 155.52-Mbit/s serial data stream. This device has pseudo-ECL-compatible or ECL-compatible inputs and ECL-compatible outputs and operates from a single 5-V supply. Pseudo-ECL levels are ECL levels referenced to 5 V instead of ground.

Since the incoming 155.52-Mbit/s data stream does not contain a 155.52-MHz frequency component, a transition detector, shown in the clock-recovery block diagram, is used as a frequency doubler to generate this frequency. The output of the transition detector is passed to a phase/frequency detector where it is compared to the output of the VCO. The phase/frequency detector is actually comprised of two circuits. One circuit provides a coarse frequency-detection capability and a second provides a finer phase adjustment. The phase/frequency detector compares the signal from the transition detector to the VCO output and generates signals to either increase or decrease the VCO frequency depending upon whether the VCO frequency is less than or greater than the frequency of the signal from the transition detector. The up/down pulses are sent to the charge pump/loop filter for conversion to a bias voltage that sets the VCO output frequency.

The process of comparing the input signal frequency and the VCO output frequency is continuous and eventually results in the VCO output frequency equaling the frequency of the input signal. It also allows the VCO output to react to changes in the input signal due to jitter. The recovered clock output is sent from the VCO to the retiming circuit where the input data is retimed to the recovered clock. The retiming circuit centers the output clock in the middle of the output data.

clock-recovery block diagram



performance measurements

Measuring the performance of a clock-recovery circuit involves determining how well the circuit operates in the presence of jitter. Jitter is defined as the short-term variations of a digital signals significant instants from their ideal positions in time.[†] For testing purposes, jitter is usually generated by modulating a digital data sequence with a sinusoidal waveform of a known frequency. This results in a digital data stream where the widths of the individual data pulses varies with time. The amount of pulse width variation can be changed by altering the frequency and amplitude of the modulating signal, which changes the amount of jitter in the data stream. The following paragraphs describe the test results obtained from the TNETA1556 for various performance measurements.

[†] Bellcore technical reference TR-TSY-000499 Issue 3, December 1989, page 7-1.

TNETA1556

155.52-MBIT/S CLOCK-RECOVERY DEVICE

SDNS015C – FEBRUARY 1994 – REVISED JUNE 1995

APPLICATION INFORMATION

RMS jitter

This test provides a measure of the internal jitter performance of the clock-recovery circuit. A data stream with very low jitter (all data generators have a small amount of jitter) is input to the clock-recovery device, and the jitter of the recovered clock is measured. A $2^{31}-1$ pseudo-random bit sequence (PRBS) is used for the input data stream. For this test, the worst-case jitter performance was measured with $V_{CC} = 4.75$ V at a free-air operating temperature of 85°C. Table 1 summarizes these test results.

Table 1. Worst-Case RMS Jitter Measurement, $V_{CC} = 4.75$ V, $T_A = 85^\circ\text{C}$

DEVICE NO.	1	2	3	4	5	6	7	8	9
Jitter ($^\circ\text{RMS}$)	3.5	3.2	3.5	3.3	3.1	3.5	3.1	3	3.4

jitter tolerance

Jitter tolerance is a measure of the ability of the clock-recovery circuit to tolerate an input signal without experiencing a bit error. For this test, the Bellcore SONET category II jitter-tolerance mask was used (Bellcore specification TR-NWT-000253). The worst-case performance was measured with $V_{CC} = 5.25$ V at a free-air temperature of 85°C. Table 2 and Figure 2 show the results for this test.

Table 2. Jitter-Tolerance Values Used in the Graph of Figure 2

FREQUENCY H_3	BELLCORE	TNETS1556
10	15	NA
30	15	NA
300	1.5	10
1k	1.5	10
2k	1.5	10
5k	0.81	10
10k	0.3	1
20k	0.15	1
50k	0.15	1
100k	0.15	0.658
200k	0.15	0.382
500k	0.15	0.34
1m	0.15	0.536
2m	0.15	0.515
3.5m	0.15	0.486
4m	0.15	0.493

PRODUCT PREVIEW



POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

APPLICATION INFORMATION

jitter tolerance (continued)

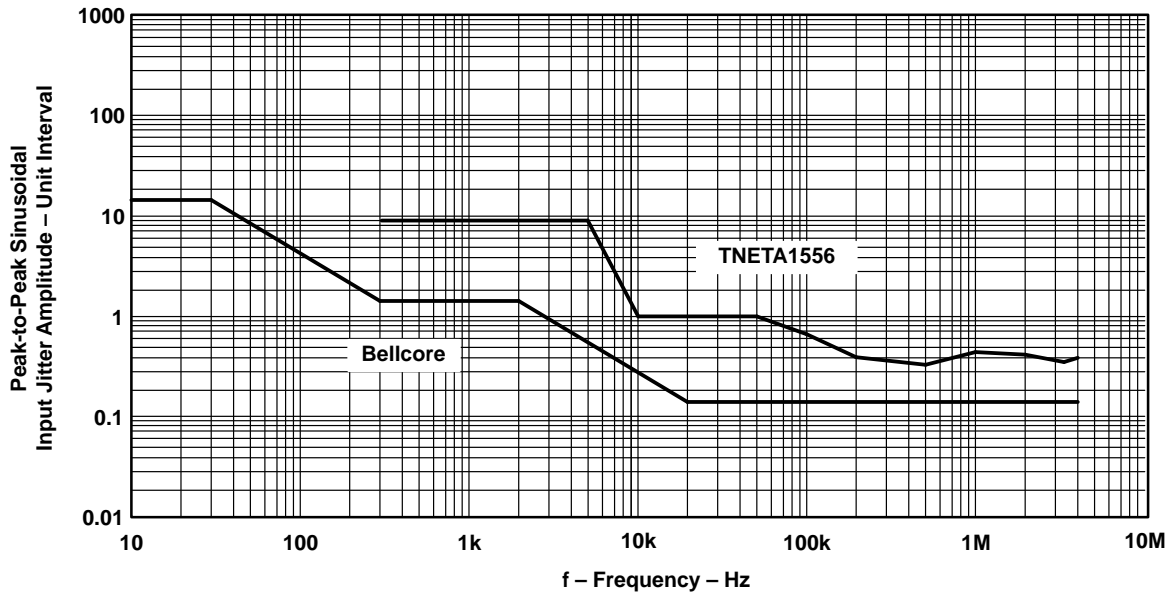


Figure 2. Jitter Tolerance (worst case)

transitionless bit periods

The SONET/SDH specifications do not use a line code that limits the number of transitionless bit periods in a bit stream to a specific number. Instead, a scrambler is used to provide some randomization of the line signal. As long as the output data stream does not match the output of the scrambler, this technique works fairly well. However, it is possible for the scrambled data stream to contain a large number of transitionless bit periods, depending upon the data being transmitted. It is important that the clock-recovery device handle large numbers of transitionless bit periods without causing a bit error. Figures 3 and 4 show the results of tests conducted on the TNETA1556 for transitionless bit periods. The y-axis shows the number of transitionless bit periods that the devices can accept before a bit error is recorded on the bit-error rate tester.

PRODUCT PREVIEW

TNETA1556

155.52-MBIT/S CLOCK-RECOVERY DEVICE

SDNS015C – FEBRUARY 1994 – REVISED JUNE 1995

APPLICATION INFORMATION

transitionless bit periods (continued)

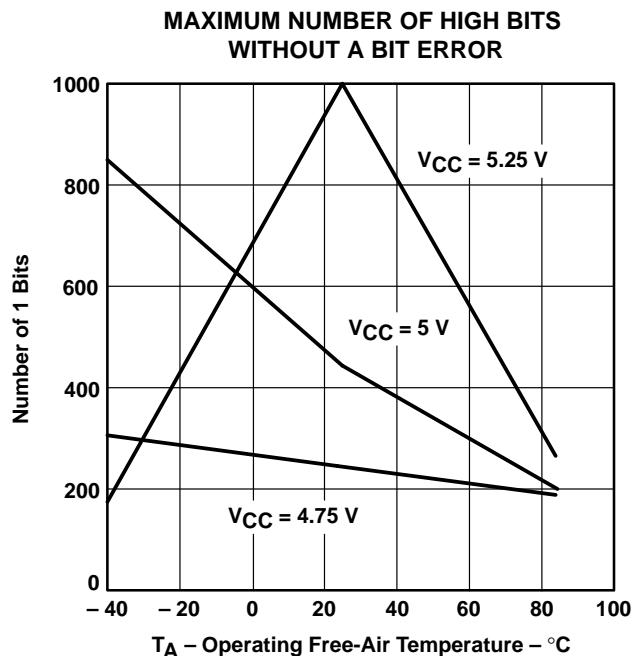


Figure 3

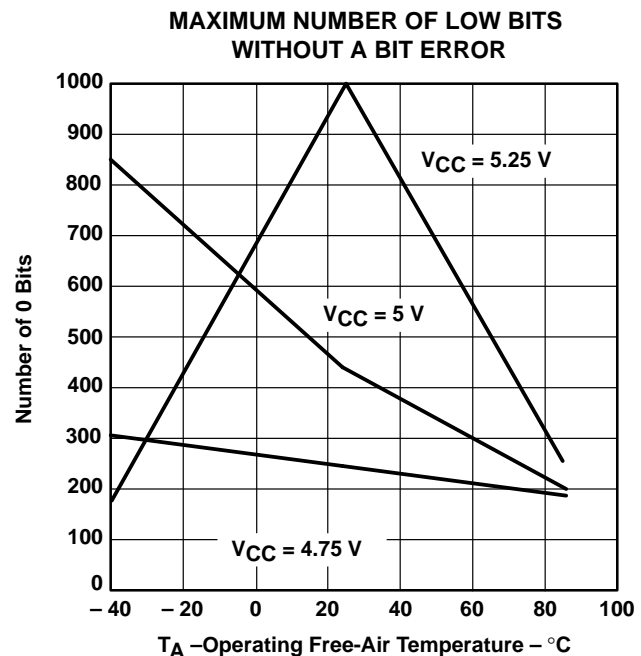


Figure 4

jitter transfer (peaking and bandwidth)

SONET/SDH regenerator interfaces are required to meet jitter-transfer requirements. Jitter transfer is the ratio of measured output jitter to applied input jitter, and it is measured in decibels. Meeting the jitter-transfer requirement in SONET/SDH regenerators requires either a clock-recovery circuit with a voltage-controlled crystal oscillator (VCXO) or a similar technique that provides extremely low jitter. The TNETA1556 provides a typical jitter-transfer bandwidth of approximately 2 MHz. This is where the device begins to attenuate the input jitter so that the output jitter is less than the input jitter. The device exhibits minimal jitter peaking when a capacitor of approximately 0.1 μF is used in the loop filter. The peaking is less than 0.3 dB, which is the resolution of the test equipment used to measure this parameter.

external connections

loop-filter capacitor

The capacitor for the loop filter is connected from terminal 2 of the TNETA1556 to ground. It is recommended that a 0.1- μF chip capacitor be used. A smaller capacitor reduces the amount of acquisition time required for the device to lock on to the input data stream while it increases the amount of jitter peaking that can occur. A larger capacitor results in a longer acquisition time and does not provide any noticeable increase in jitter performance.

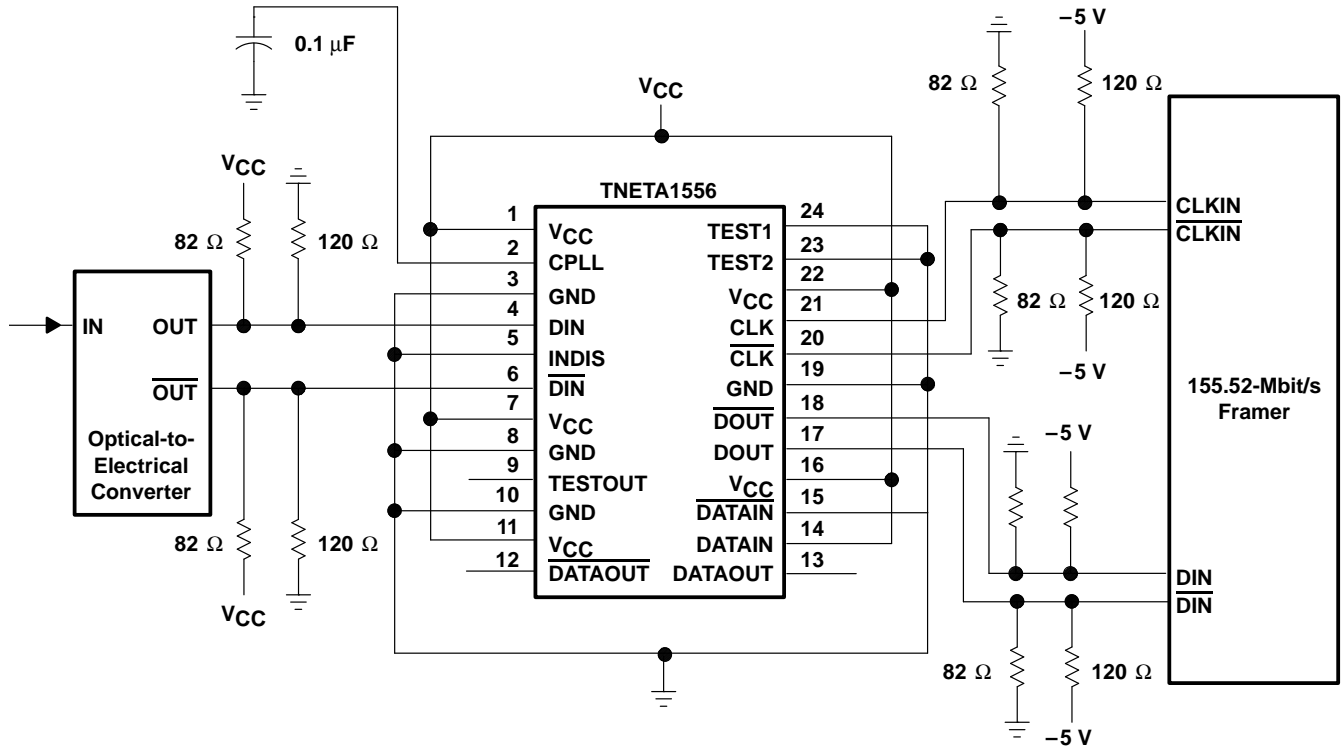
signal connections

Figure 5 shows a typical connection between the TNETA1556, an optical-to-electrical converter, and a framer device. The TNETA1556 accepts pseudo-ECL-compatible or ECL-compatible signals at the serial data inputs DIN and $\overline{\text{DIN}}$. The retimed ECL clock outputs are provided at outputs CLK and $\overline{\text{CLK}}$. The pseudo-ECL inputs require a 50- Ω termination to $V_{CC} - 2\text{ V}$ (or a Thevenin equivalent). The Thevenin-equivalent circuit consists of an 82- Ω resistor to V_{CC} and 120- Ω resistor to ground. The ECL outputs require a 50- Ω termination to -2 V (or a Thevenin equivalent). The Thevenin-equivalent circuit consists of an 82- Ω resistor to ground and 120- Ω resistor to -5 V .

APPLICATION INFORMATION

signal connections (continued)

A separate PECL-to-ECL converter is also provided on the TNETA1556. The PECL inputs require a 50-Ω to $V_{CC} - 2\text{ V}$ termination (or a Thevenin equivalent) and the ECL outputs require a 50-Ω to -2 V termination (or its equivalent). Figure 6 shows the external connections for the PECL-to-ECL converter.



- NOTES: A. Terminating resistors should be placed as close to the input terminal as possible.
 B. The 0.1-μF bypass capacitors are connected from the V_{CC} terminals to ground.

Figure 5. TNETA1556 External Connections (PECL-to-ECL converter not used)

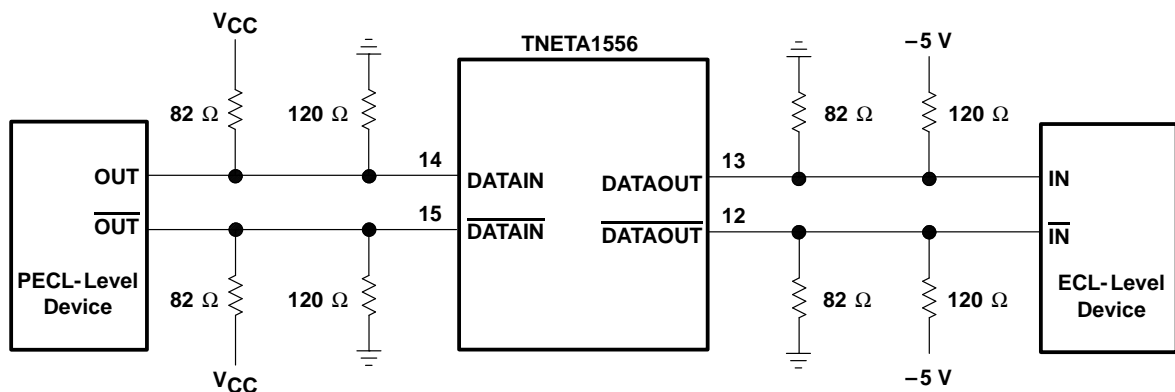


Figure 6. External Connections for PECL-to-ECL Converter

PRODUCT PREVIEW

IMPORTANT NOTICE

Texas Instruments (TI) reserves the right to make changes to its products or to discontinue any semiconductor product or service without notice, and advises its customers to obtain the latest version of relevant information to verify, before placing orders, that the information being relied on is current.

TI warrants performance of its semiconductor products and related software to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

Certain applications using semiconductor products may involve potential risks of death, personal injury, or severe property or environmental damage ("Critical Applications").

TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, INTENDED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT APPLICATIONS, DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS.

Inclusion of TI products in such applications is understood to be fully at the risk of the customer. Use of TI products in such applications requires the written approval of an appropriate TI officer. Questions concerning potential risk applications should be directed to TI through a local SC sales office.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards should be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance, customer product design, software performance, or infringement of patents or services described herein. Nor does TI warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used.